

# Schottky Barrier Diode

## Features

1. High reliability
2. Very low forward voltage
3. Small surface mounting type



## Applications

Applications where a very low forward voltage is required

## Absolute Maximum Ratings

$T_j=25^{\circ}\text{C}$

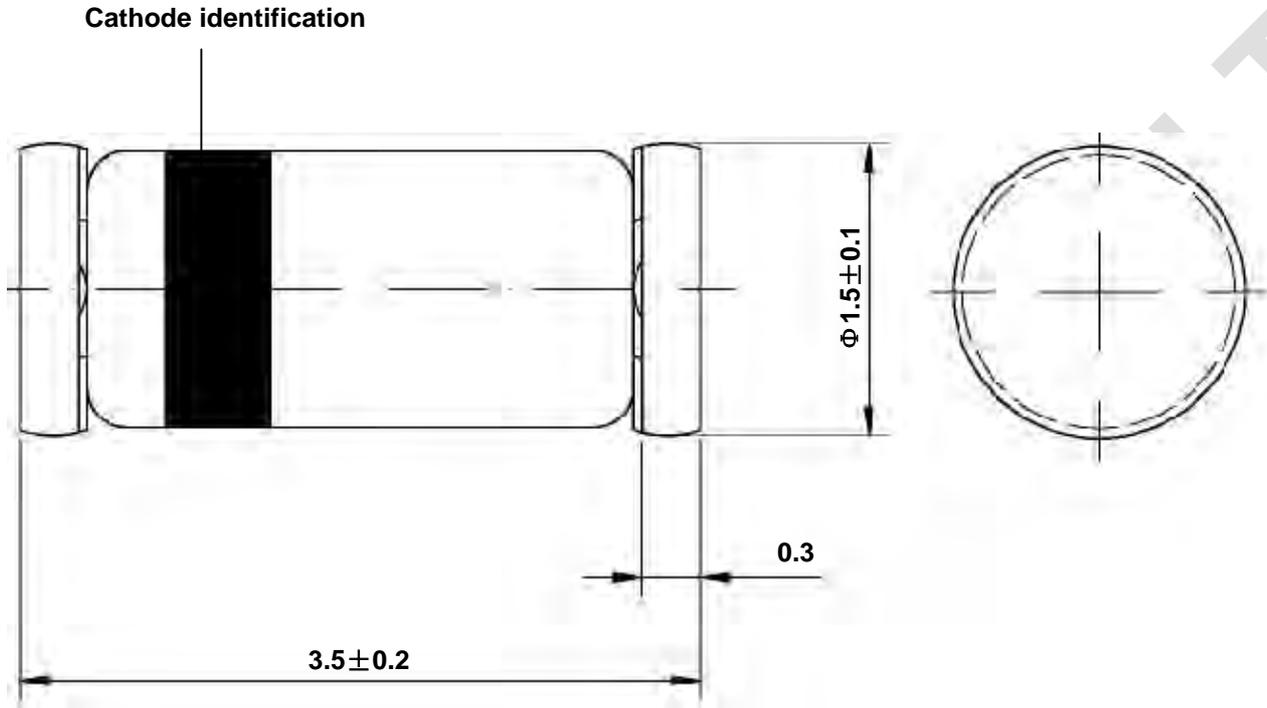
| Parameter                           | Test Conditions                                    | Symbol    | Value    | Unit               |
|-------------------------------------|--|-----------|----------|--------------------|
| Continuous reverse voltage          |  | $V_R$     | 30       | V                  |
| Forward continuous current          | $T_{amb}=25^{\circ}\text{C}$                       | $I_F$     | 200      | mA                 |
| Peak forward current                | $T_{amb}=25^{\circ}\text{C}$                       | $I_{FM}$  | 300      | mA                 |
| Surge forward current               | $t_p \leq 1 \text{ s}, T_{amb}=25^{\circ}\text{C}$ | $I_{FSM}$ | 600      | mA                 |
| Power dissipation                   | $T_{amb}=65^{\circ}\text{C}$                       | $P_{tot}$ | 200      | mW                 |
| Maximum junction temperature        |  | $T_j$     | 125      | $^{\circ}\text{C}$ |
| Ambient operating temperature range |  | $T_A$     | -65~+125 | $^{\circ}\text{C}$ |
| Storage temperature range           |  | $T_{stg}$ | -65~+150 | $^{\circ}\text{C}$ |

## Maximum Thermal Resistance

$T_j=25^{\circ}\text{C}$

| Parameter        | Test Conditions             | Symbol     | Value | Unit |
|------------------|-----------------------------|------------|-------|------|
| Junction ambient | on PC board 50mm×50mm×1.6mm | $R_{thJA}$ | 250   | K/W  |

## Dimensions in mm



Glass Case  
Mini Melf / SOD 80  
JEDEC DO 213 AA

**Characteristics** ( $T_j=25^\circ\text{C}$  unless otherwise specified)

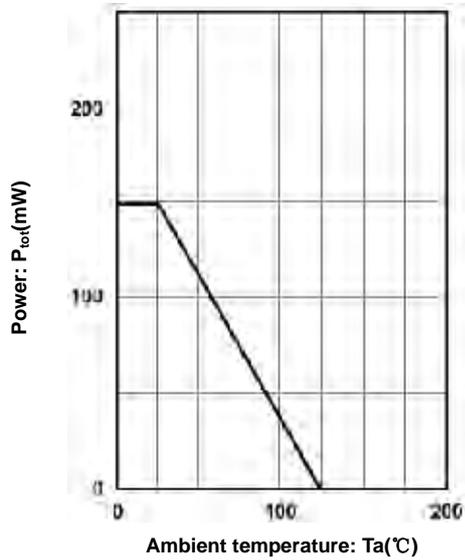


Figure 1. Admissible power dissipation vs. ambient temperature

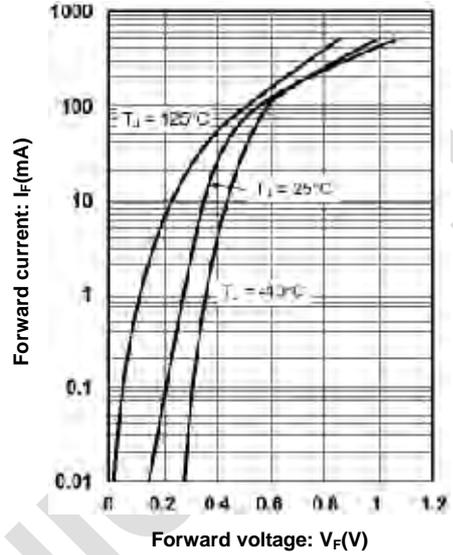


Figure 2. Typical instantaneous forward characteristics

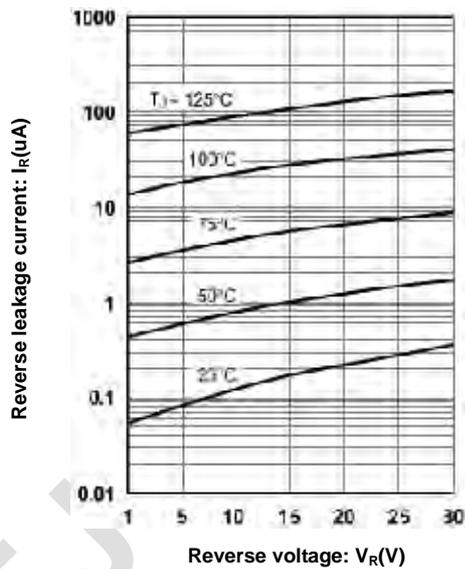


Figure 3. Typical reverse characteristics

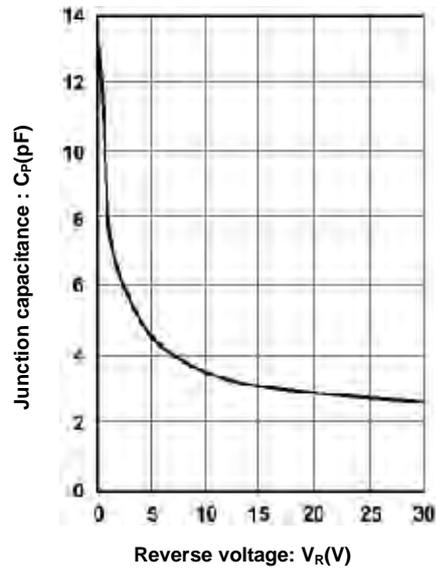


Figure 4. Typical junction capacitance

## Electrical Characteristics

T<sub>j</sub>=25°C

| Parameter  | Symbol             | Test Conditions   | Min | Typ | Max  | Unit |
|--|--------------------|---|-----|-----|------|------|
| Reverse breakdown voltage                                    | V <sub>(BR)R</sub> | I <sub>R</sub> =10 μ A (pulsed)   | 30  | -   | -    | V    |
| Leakage current  | I <sub>R</sub>     | V <sub>R</sub> =25V   | -   | -   | 2    | μ A  |
| Forward voltage<br>Pulse test t <sub>p</sub> <300 μ s, δ <2% | V <sub>F</sub>     | I <sub>F</sub> =0.1mA   | -   | -   | 0.24 | V    |
|  |                    | I <sub>F</sub> =1mA   | -   | -   | 0.32 | V    |
|  |                    | I <sub>F</sub> =10mA  | -   | -   | 0.4  | V    |
|  |                    | I <sub>F</sub> =30mA  | -   | 0.5 | -    | V    |
|  |                    | I <sub>F</sub> =100mA   | -   | -   | 0.8  | V    |
| Capacitance  | C <sub>tot</sub>   | V <sub>R</sub> =1V, f=1MHz  | -   | -   | 10   | pF   |
| Reverse recovery time  | t <sub>rr</sub>    | I <sub>F</sub> =10mA to I <sub>R</sub> =10mA<br>to I <sub>R</sub> =0.1mA I <sub>R</sub> | -   | -   | 5    | ns   |